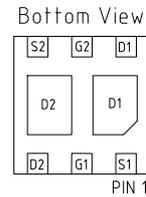
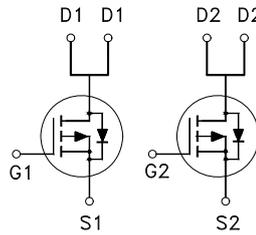


Dual P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                     |              |
|---------------------|--------------|
| $BV_{DSS}$          | -20V         |
| $R_{DS(on)}$ (MAX.) | 65m $\Omega$ |
| $I_D$               | -3A          |



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ }^\circ\text{C}$  Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |                                  | SYMBOL         | LIMITS     | UNIT             |
|--|----------------------------------|----------------|------------|------------------|
| Gate-Source Voltage                            |                                  | $V_{GS}$       | $\pm 8$    | V                |
| Continuous Drain Current                       | $T_A = 25\text{ }^\circ\text{C}$ | $I_D$          | -3         | A                |
|  | $T_A = 70\text{ }^\circ\text{C}$ |                | -2         |                  |
| Pulsed Drain Current <sup>1</sup>              |                                  | $I_{DM}$       | -12        |                  |
| Power Dissipation                              | $T_A = 25\text{ }^\circ\text{C}$ | $P_D$          | 1.9        | W                |
|  | $T_A = 70\text{ }^\circ\text{C}$ |                | 1.2        |                  |
| Operating Junction & Storage Temperature Range |                                  | $T_j, T_{stg}$ | -55 to 150 | $^\circ\text{C}$ |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE               | SYMBOL          | TYPICAL | MAXIMUM | UNIT                      |
|----------------------------------|-----------------|---------|---------|---------------------------|
| Junction-to-Case                 | $R_{\theta JC}$ |         | 15      | $^\circ\text{C}/\text{W}$ |
| Junction-to-Ambient <sup>3</sup> | $R_{\theta JA}$ |         | 65      |                           |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle  $\leq 1\%$

<sup>3</sup>65 $^\circ\text{C}/\text{W}$  when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ , Unless Otherwise Noted)

| PARAMETER   | SYMBOL        | TEST CONDITIONS   | LIMITS |       |           | UNIT       |
|---|---------------|---|--------|-------|-----------|------------|
|   |               |   | MIN    | TYP   | MAX       |            |
| <b>STATIC</b>   |               |   |        |       |           |            |
| Drain-Source Breakdown Voltage  | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = -250\mu A$                                | -20    |       |           | V          |
| Gate Threshold Voltage  | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = -250\mu A$                            | -0.35  | -0.60 | -0.85     |            |
| Gate-Body Leakage   | $I_{GSS}$     | $V_{DS} = 0V, V_{GS} = \pm 8V$                                |        |       | $\pm 100$ | nA         |
| Zero Gate Voltage Drain Current   | $I_{DSS}$     | $V_{DS} = -16V, V_{GS} = 0V$                                  |        |       | -1        | $\mu A$    |
|   |               | $V_{DS} = -16V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$ |        |       | -10       |            |
| On-State Drain Current <sup>1</sup>   | $I_{D(ON)}$   | $V_{DS} = -5V, V_{GS} = -4.5V$                                | -3     |       |           | A          |
| Drain-Source On-State Resistance <sup>1</sup>   | $R_{DS(ON)}$  | $V_{GS} = -4.5V, I_D = -3A$                                   |        | 52    | 65        | m $\Omega$ |
|   |               | $V_{GS} = -2.5V, I_D = -2A$                                   |        | 78    | 100       |            |
|   |               | $V_{GS} = -1.8V, I_D = -1A$                                   |        | 100   | 140       |            |
| Forward Transconductance <sup>1</sup>   | $g_{fs}$      | $V_{DS} = -5V, I_D = -3A$                                     |        | 10    |           | S          |
| <b>DYNAMIC</b>  |               |   |        |       |           |            |
| Input Capacitance   | $C_{iss}$     | $V_{GS} = 0V, V_{DS} = -10V, f = 1MHz$                        |        | 382   |           | pF         |
| Output Capacitance  | $C_{oss}$     |   |        | 70    |           |            |
| Reverse Transfer Capacitance  | $C_{rss}$     |   |        | 60    |           |            |
| Total Gate Charge <sup>1,2</sup>  | $Q_g$         | $V_{DS} = -10V, V_{GS} = -4.5V, I_D = -3A$                    |        | 7.2   |           | nC         |
| Gate-Source Charge <sup>1,2</sup>   | $Q_{gs}$      |   |        | 1.2   |           |            |
| Gate-Drain Charge <sup>1,2</sup>  | $Q_{gd}$      |   |        | 2.3   |           |            |
| Turn-On Delay Time <sup>1,2</sup>   | $t_{d(on)}$   | $V_{DS} = -10V, I_D = -1A, V_{GS} = -4.5V, R_{GS} = 6\Omega$  |        | 17    |           | nS         |
| Rise Time <sup>1,2</sup>  | $t_r$         |   |        | 32    |           |            |
| Turn-Off Delay Time <sup>1,2</sup>  | $t_{d(off)}$  |   |        | 37    |           |            |
| Fall Time <sup>1,2</sup>  | $t_f$         |   |        | 32    |           |            |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_C = 25\text{ }^\circ\text{C}</math>)</b> |               |   |        |       |           |            |
| Continuous Current  | $I_S$         |   |        |       | -3        | A          |
| Pulsed Current <sup>3</sup>   | $I_{SM}$      |   |        |       | -12       |            |
| Forward Voltage <sup>1</sup>  | $V_{SD}$      | $I_F = I_S, V_{GS} = 0V$                                      |        |       | -1.2      | V          |

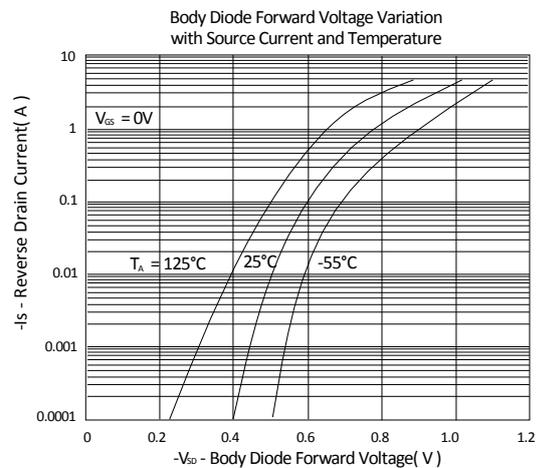
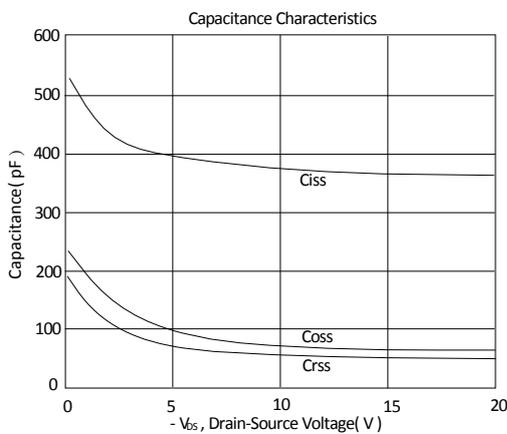
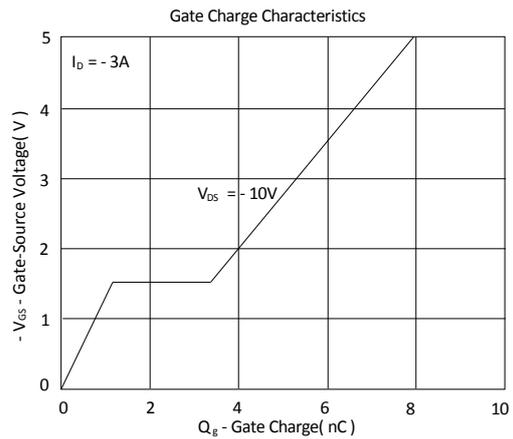
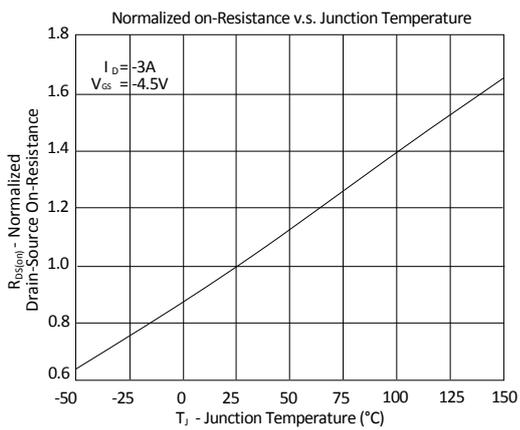
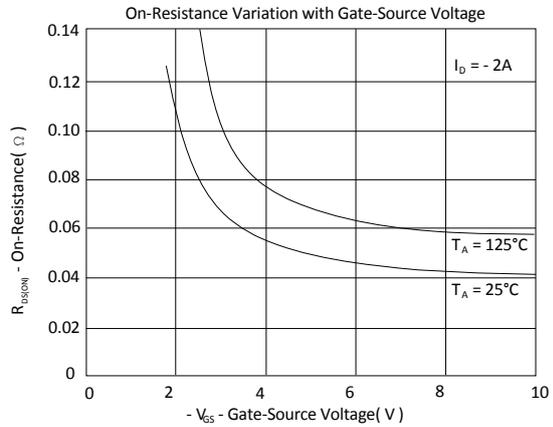
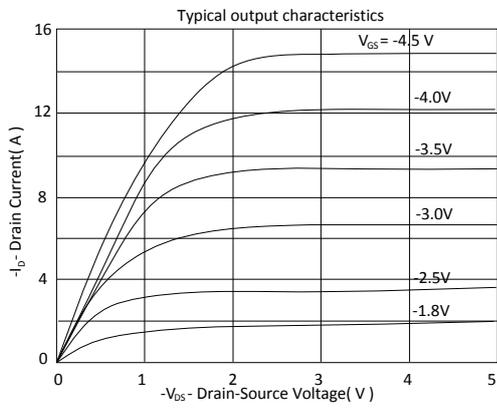
<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

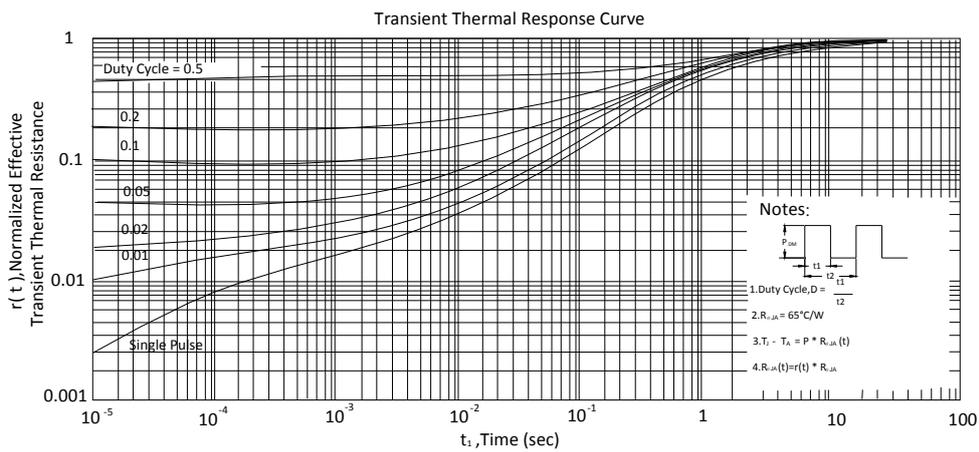
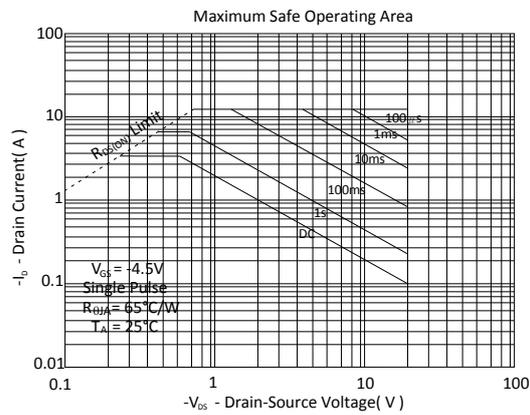
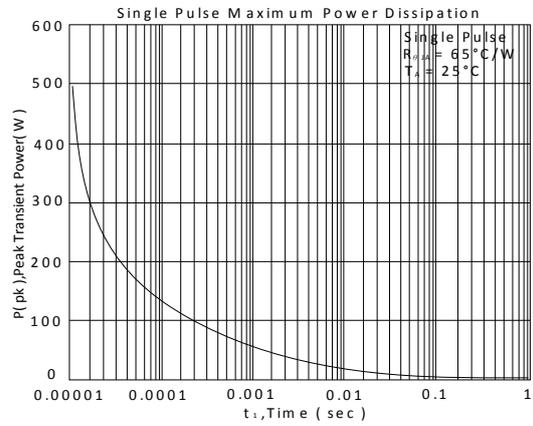
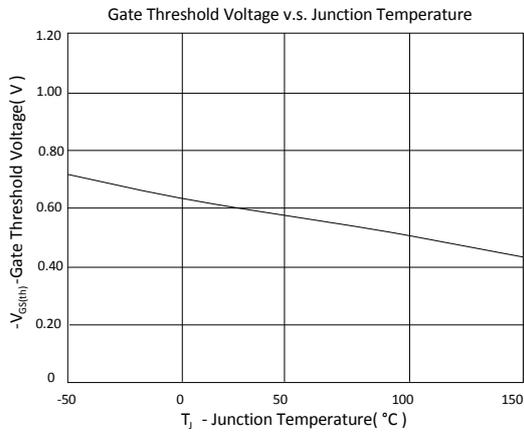
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.



TYPICAL CHARACTERISTICS

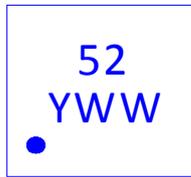






Ordering & Marking Information:

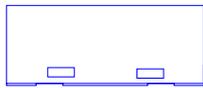
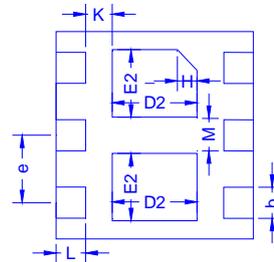
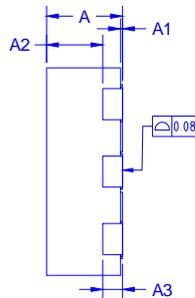
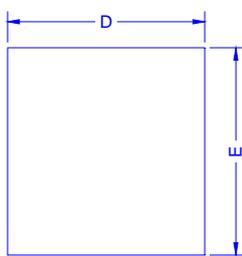
Device Name: EMF60B02VA for EDFN 2 x 2



→ 52: Device Name, 52 for EMF60B02VA

→ YWW: Date Code

Outline Drawing



Dimension in mm

| Dimension | A    | A1   | A2   | A3          | b    | D    | E    | D2   | E2   | e    | H           | K    | L    | M    |
|-----------|------|------|------|-------------|------|------|------|------|------|------|-------------|------|------|------|
| Min.      | 0.70 | 0.00 | 0.50 | 0.20<br>REF | 0.25 | 1.90 | 1.90 | 0.76 | 0.55 | 0.55 | 0.20<br>REF | 0.17 | 0.25 | 0.25 |
| Max.      | 0.80 | 0.05 | 0.60 |             | 0.35 | 2.10 | 2.10 | 0.96 | 0.75 | 0.75 |             | 0.37 | 0.35 | 0.45 |

Recommended minimum pads

